Quad low-to-high voltage translator with 3-state outputsRev. 8 — 11 November 2011Product data

Product data sheet

#### **General description** 1.

The HEF4104B is a quad low voltage-to-high voltage translator with 3-state outputs. It provides the capability of interfacing low voltage circuits to high voltage circuits. For example low voltage Local Oxidation Complementary MOS (LOCMOS) and Transistor-Transistor Logic (TTL) to high voltage LOCMOS. It has four data inputs (A0 to A3), an active HIGH output enable input (OE), four data outputs (B0 to B3) and their complements (B0 to B3).

With OE = HIGH, the outputs B0 to B3 and B0 to B3 are in the low impedance ON-state, either HIGH or LOW as determined by the inputs A0 to A3. With OE = LOW, the outputs B0 to B3 and B0 to B3 are in the high-impedance OFF-state.

It uses a common negative supply ( $V_{SS}$ ) and separate positive supplies for the inputs  $(V_{DD(A)})$  and the outputs  $(V_{DD(B)})$ .  $V_{DD(A)}$  must always be less than or equal to  $V_{DD(B)}$ , even during power turn-on and turn-off. For the permissible operating range of V<sub>DD(A)</sub> and V<sub>DD(B)</sub> see Figure 4.

Each input protection circuit is terminated between  $V_{DD(B)}$  and  $V_{SS}$ . This allows the input signals to be driven from any potential between V<sub>DD(B)</sub> and V<sub>SS</sub>, without regard to current limiting. When driving from potentials greater than  $V_{DD(B)}$  or less than  $V_{SS}$ , the current at each input must be limited to 10 mA.

It operates over a recommended  $V_{DD}$  power supply range of 3 V to 15 V referenced to  $V_{SS}$ (usually ground). Unused inputs must be connected to V<sub>DD</sub>, V<sub>SS</sub>, or another input.

#### 2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Inputs and outputs are protected against electrostatic effects
- Specified from –40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B



Quad low-to-high voltage translator with 3-state outputs

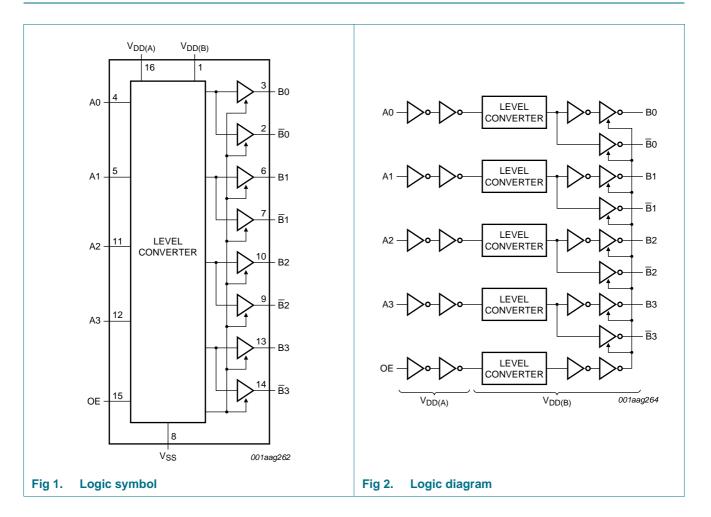
## 3. Ordering information

### Table 1. Ordering information

All types operate from -40 ℃ to +85 ℃.

Type number	Package					
	Name	Description	Version			
HEF4104BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4			
HEF4104BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1			

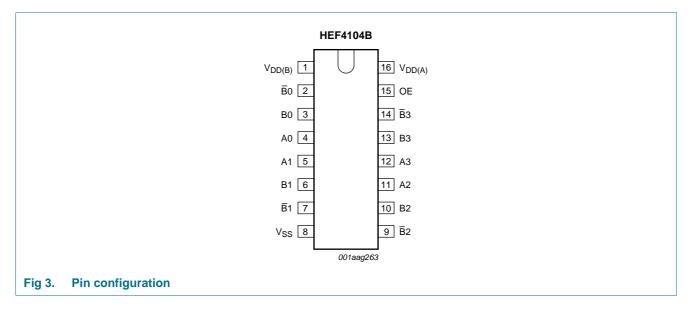
## 4. Functional diagram



Quad low-to-high voltage translator with 3-state outputs

## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
V <sub>DD(B)</sub>	1	supply voltage port B
$\overline{B}0$ to $\overline{B}3$	2, 7, 9, 14	complementary data output
B0 to B3	3, 6, 10, 13	data output
A0 to A3	4, 5, 11, 12	data input
V <sub>SS</sub>	8	common negative supply voltage (0 V)
OE	15	output enable input
V <sub>DD(A)</sub>	16	supply voltage port A
-		

## 6. Functional description

### Table 3.Function table

	Output	
OE	Bn	Bn
н	An	Ān
L	Z	Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

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## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 V$  (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD(A)</sub>	supply voltage A	port A; $V_{DD(A)} \leq V_{DD(B)}$	-0.5	+18	V
V <sub>DD(B)</sub>	supply voltage B	port B; $V_{DD(B)} \ge V_{DD(A)}$	-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm DD(A)}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	$V_{DD(A)} + 0.5$	V
Ι <sub>ΟΚ</sub>	output clamping current	$V_O < -0.5$ V or $V_O > V_{DD(B)}$ + 0.5 V	-	±10	mA
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		<u>[1]</u> -	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+85	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +85 $^{\circ}C$			
		DIP16	[2] _	750	mW
		SO16	<u>[3]</u>	500	mW
Р	power dissipation	per output	-	100	mW

[1]  $I_{DD}$  is the combined current of  $I_{DD(A)}$  and  $I_{DD(B)}$ .

[2] For DIP16 packages: above  $T_{amb}$  = 70 °C,  $P_{tot}$  derates linearly at 12 mW/K.

[3] For SO16 packages: above  $T_{amb}$  = 70 °C,  $P_{tot}$  derates linearly at 8 mW/K.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DD(A)</sub>	supply voltage A		3	-	$\leq V_{DD(B)}$	V
V <sub>DD(B)</sub>	supply voltage B		$\geq V_{DD(A)}$	-	15	V
VI	input voltage		0	-	V <sub>DD(A)</sub>	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{DD(A)} = 5 V$	-	-	3.75	μs/V
		$V_{DD(A)} = 10 V$	-	-	0.5	μs/V
		V <sub>DD(A)</sub> = 15 V	-	-	0.08	μs/V

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## 9. Static characteristics

### Table 6. Static characteristics

 $V_{DD(A)} = V_{DD(B)}$ ;  $V_{SS} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD(A)}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>DD</sub> [1]	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> =	+25 °C	T <sub>amb</sub> =	+85 °C	Unit
				Min	Max	Min	Max	Min	Max	1
V <sub>IH</sub>	HIGH-level	<b>I</b> <sub>O</sub>   < 1 μA	5 V	3.5	-	3.5	-	3.5	-	V
input volta	input voltage		10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
VIL	LOW-level	<b>I</b> <sub>O</sub>   < 1 μA	5 V	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V <sub>OH</sub>	HIGH-level	<b>I</b> <sub>O</sub>   < 1 μA	5 V	4.95	-	4.95	-	4.95	-	V
	output voltage		10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V <sub>OL</sub>	LOW-level	I <sub>O</sub>   < 1 μΑ	5 V	-	0.05	-	0.05	-	0.05	V
	output voltage		10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I <sub>OH</sub>	HIGH-level output current	$V_0 = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
		$V_{O} = 4.6 V$	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.3	-	-1.1	-	-0.9	mA
		V <sub>O</sub> = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mA
I <sub>OL</sub>	LOW-level	$V_{O} = 0.4 V$	5 V	0.52	-	0.44	-	0.36	-	mA
	output current	$V_{O} = 0.5 V$	10 V	1.3	-	1.1	-	0.9	-	mA
		V <sub>O</sub> = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mΑ
l <sub>l</sub>	input leakage current		15 V	-	±0.3	-	±0.3	-	±1.0	μΑ
I <sub>DD</sub>	supply current	all valid input	5 V 🛛	2] _	20	-	20	-	150	μΑ
		combinations; I <sub>O</sub> = 0 A	10 V	-	40	-	40	-	300	μΑ
		10 = 0  A	15 V	-	80	-	80	-	600	μΑ
l <sub>oz</sub>	OFF-state output current	HIGH level; V <sub>O</sub> = V <sub>DD(B)</sub>	15 V	-	1.6	-	1.6	-	12.0	μΑ
		LOW level; V <sub>O</sub> = V <sub>SS</sub>	15 V	-	-1.6	-	-1.6	-	-12.0	μΑ
CI	input capacitance	digital inputs	-	-	-	-	7.5	-	-	pF

[1]  $V_{DD}$  is the same as  $V_{DD(A)}$  and  $V_{DD(B)}$ .

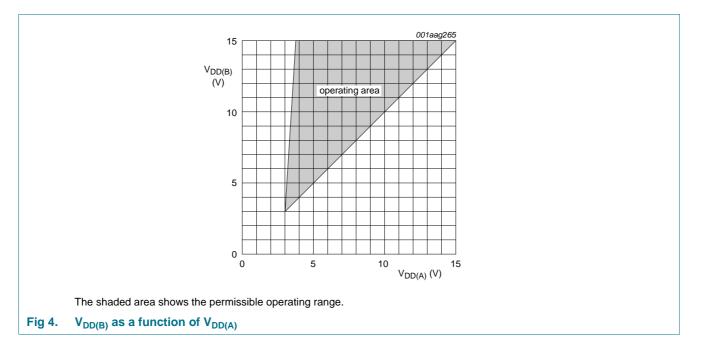
[2]  $I_{DD}$  is the combined current of  $I_{DD(A)}$  and  $I_{DD(B)}$ .

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# **HEF4104B**

### Quad low-to-high voltage translator with 3-state outputs



## **10. Dynamic characteristics**

#### Table 7. Dynamic characteristics

 $T_{amb} = 25 \text{ °C}$ ; for test circuit see Figure 7; unless otherwise specified.

Symbol	Parameter	Conditions	Extrapolation formula <sup>[1]</sup>	Min	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW	An to Bn, Bn; see Figure 5					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 V$	143 ns + (0.55 ns/pF)C <sub>L</sub>	-	170	340	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$	69 ns + (0.23 ns/pF)C <sub>L</sub>	-	80	160	ns
		$V_{DD(A)} = V_{DD(B)} = 15 V$	57 ns + (0.16 ns/pF)C <sub>L</sub>	-	65	135	ns
t <sub>PLH</sub>	LOW to HIGH	An to Bn, Bn; see Figure 5					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 V$	143 ns + (0.55 ns/pF)C <sub>L</sub>	-	170	340	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$	69 ns + (0.23 ns/pF)C <sub>L</sub>	-	80	160	ns
		$V_{DD(A)} = V_{DD(B)} = 15 V$	62 ns + (0.16 ns/pF)C <sub>L</sub>	-	70	140	ns
t <sub>THL</sub>	HIGH to LOW output transition time	Bn or Bn; see Figure 6					
		$V_{DD(A)} = V_{DD(B)} = 5 V$	10 ns + (1.00 ns/pF)C <sub>L</sub>	-	60	120	ns
		$V_{DD(A)} = V_{DD(B)} = 10 V$	9 ns + (0.42 ns/pF)C <sub>L</sub>	-	30	60	ns
		$V_{DD(A)} = V_{DD(B)} = 15 V$	6 ns + (0.28 ns/pF)C <sub>L</sub>	-	20	40	ns
t <sub>TLH</sub>	LOW to HIGH output	Bn or Bn; see Figure 6					
	transition time	$V_{DD(A)} = V_{DD(B)} = 5 V$	10 ns + (1.00 ns/pF)C <sub>L</sub>	-	60	120	ns
		$V_{DD(A)} = V_{DD(B)} = 10 V$	9 ns + (0.42 ns/pF)C <sub>L</sub>	-	30	60	ns
		$V_{DD(A)} = V_{DD(B)} = 15 V$	6 ns + (0.28 ns/pF)C <sub>L</sub>	-	20	40	ns
t <sub>PHZ</sub>	HIGH to OFF-state	OE to Bn, Bn; see Figure 6					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 V$		-	70	135	ns
		$V_{DD(A)} = V_{DD(B)} = 10 V$		-	55	110	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$		-	60	120	ns

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### Quad low-to-high voltage translator with 3-state outputs

Symbol	Parameter	Conditions	Extrapolation formula <sup>[1]</sup>	Min	Тур	Max	Unit
t <sub>PLZ</sub>	LOW to OFF-state	OE to Bn, Bn; see <u>Figure 6</u>					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 V$		-	70	135	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$		-	55	105	ns
		$V_{DD(A)} = V_{DD(B)} = 15 \text{ V}$		-	55	110	ns
t <sub>PZH</sub>	OFF-state to HIGH propagation delay	OE to Bn, Bn; see Figure 6					
		$V_{DD(A)} = V_{DD(B)} = 5 V$		-	195	395	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$		-	95	195	ns
		$V_{DD(A)} = V_{DD(B)} = 15 V$		-	80	165	ns
t <sub>PZL</sub>	OFF-state to LOW	OE to Bn, Bn; see Figure 6					
	propagation delay	$V_{DD(A)} = V_{DD(B)} = 5 V$		-	195	395	ns
		$V_{DD(A)} = V_{DD(B)} = 10 \text{ V}$		-	95	190	ns
		$V_{DD(A)} = V_{DD(B)} = 15 V$		-	80	160	ns

### Table 7. Dynamic characteristics ...continued

 $T_{amb} = 25 \, ^{\circ}C$ ; for test circuit see <u>Figure 7</u>; unless otherwise specified.

[1] Typical value of the propagation delay and output transition time can be calculated with the extrapolation formula (C<sub>L</sub> in pF).

### Table 8. Dynamic power dissipation

 $V_{DD(A)} = V_{DD(B)}; V_{SS} = 0 V; t_r = t_f \le 20 ns; T_{amb} = 25$ °C.

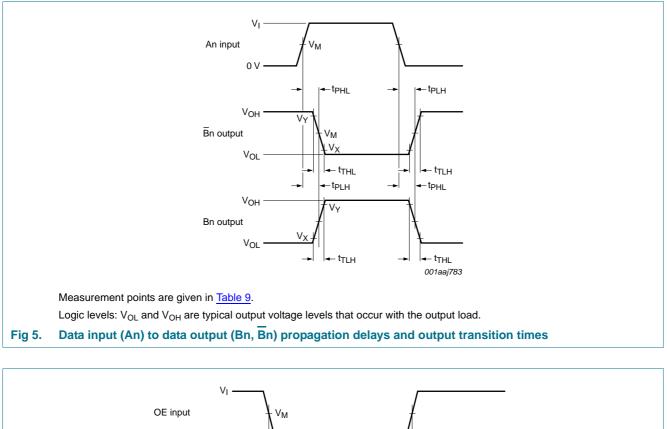
Symbol	Parameter	V <sub>DD</sub> [1]	Typical formula (μW)	where
PD	dynamic power	5 V	$P_D = 3000 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$	$f_i = input frequency in MHz;$
dissipation		10 V	$P_D = 12200 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$	$f_o = output frequency in MHz;$
		15 V	$P_{D} = 31000 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	$C_L$ = output load capacitance in pF;
				$\Sigma(f_o \times C_L)$ = sum of the outputs;
				$V_{DD}$ = supply voltage in V.

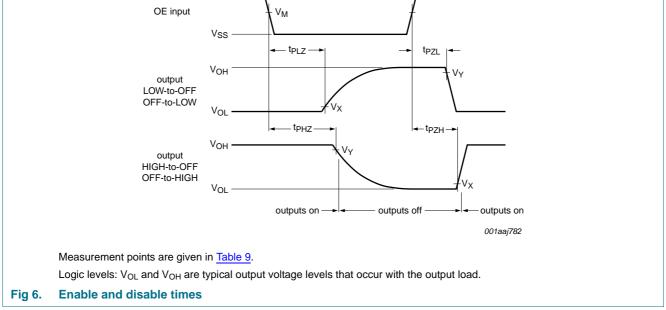
[1]  $V_{DD}$  is the same as  $V_{DD(A)}$  and  $V_{DD(B)}$ .

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### Quad low-to-high voltage translator with 3-state outputs

### 11. Waveforms





#### Table 9.Measurement points

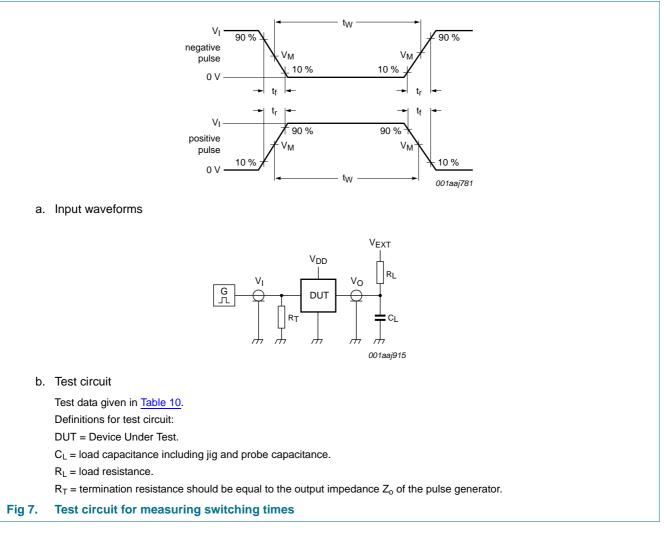
Input		Output			
VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	
$V_{\text{SS}}$ or $V_{\text{DD}(\text{A})}$	0.5V <sub>DD(A)</sub>	0.5V <sub>DD(B)</sub>	0.1V <sub>DD(B)</sub>	0.9V <sub>DD(B)</sub>	

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### Quad low-to-high voltage translator with 3-state outputs



Tab	le	10.	Test	data	
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Supplies	Input	Load		V <sub>EXT</sub>		
$V_{DD(A)} = V_{DD(B)}$	t <sub>r</sub> , t <sub>f</sub>	RL	CL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>
5 V to 15 V	$\leq$ 20 ns	1 kΩ	50 pF	open	V <sub>DD(B)</sub>	V <sub>SS</sub>

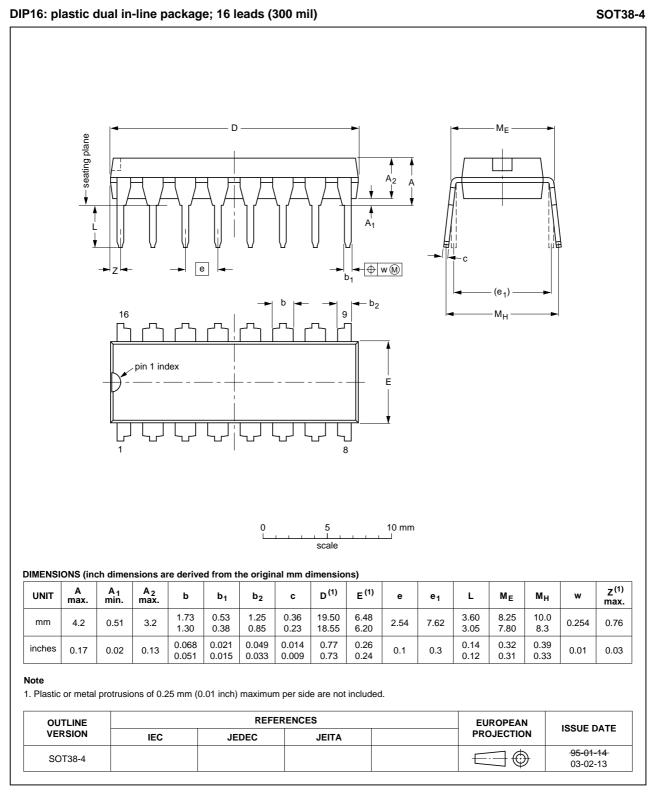
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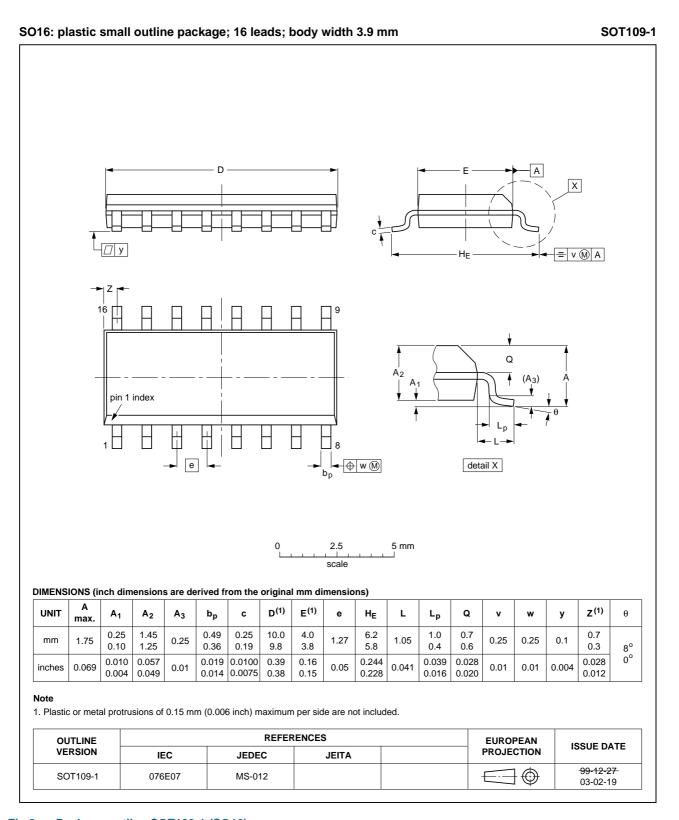
### 12. Package outline



### Fig 8. Package outline SOT38-4 (DIP16)

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Quad low-to-high voltage translator with 3-state outputs



### Fig 9. Package outline SOT109-1 (SO16)

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## 13. Revision history

Table 11. Revision hi	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4104B v.8	20111111	Product data sheet	-	HEF4104B v.7
Modifications:	<ul> <li>Section Approximation</li> </ul>	olications removed		
	• <u>Table 6</u> : I <sub>OH</sub>	minimum values changed	o maximum	
HEF4104B v.7	20091216	Product data sheet	-	HEF4104B v.6
HEF4104B v.6	20091102	Product data sheet	-	HEF4104B v.5
HEF4104B v.5	20090728	Product data sheet	-	HEF4104B v.4
HEF4104B v.4	20090305	Product data sheet	-	HEF4104B_CNV v.3
HEF4104B_CNV v.3	19950101	Product specification	-	HEF4104B_CNV v.2
HEF4104B_CNV v.2	19950101	Product specification	-	-

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## 14. Legal information

### 14.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

#### Quad low-to-high voltage translator with 3-state outputs

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